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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Z. Hu et al.

Attorney Docket No.: SEMT119899

Application No.: 10/667,795

Filed:

September 22, 2003

Title:

THIOUREA- AND CYANIDE-FREE BATH AND PROCESS FOR

ELECTROLYTIC ETCHING OF GOLD

INFORMATION DISCLOSURE STATEMENT

March 17, 2004

TO THE COMMISSIONER FOR PATENTS:

Applicants are aware of the information listed in the attached form that may be material to the prosecution of the above-identified patent application.

- 1. X Copies of the listed publications are enclosed for the Examiner's use.
- 2. _X_ Pursuant to 37 C.F.R. § 1.97(b), this Information Disclosure Statement is being filed before the mailing date of a first Office Action on the merits.

Respectfully submitted,

CHRISTENSEN O'CONNOR JOHNSON KINDNESSPLLC

Jeffrey M. Sakoi

Registration No. 32,059 Direct Dial No. 206.695.1713

I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the below date.

Date: March 17, 2004 Francon hi

JMS:snh



INFORMATION CITED BY APPLICANTS THAT MAY BE MATERIAL TO THE PROSECUTION OF THE SUBJECT APPLICATION

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U.S. PATENT DOCUMENTS

*Examiner Cite		Kind	Date	
Initials No.	. Document No.	Code	(mm/dd/yyyy)	Name
U1	3,935,005	Α	01/27/1976	Solidum et al.
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U5	4,208,378	Α	06/17/1980	Heinen et al.
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	O1	Moffat, T.P., et al., "Superconformal Electrodeposition of Copper in 500-90 nm Features," <i>Journal of The Electrochemical Society</i> 147(12):4524-4535, 2000.							
	O2	Moffat, T.P., et al., "Superconformal Electrodeposition of Copper," Electrochemical and Solid-State Letters 4(4):C26-C29, 2001.							
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*Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicants.

JMS:snh

LAW OFFICES OF CHRISTENSEN O'CONNOR JOHNSON KINDNESSruc 1420 Fifth Avenue Suite 2800 Seattle, Washington 98101 206.682.8100